ASSOCIATION CONNECTING LECTRONICS INDUSTRIES® INDUSTRIES®	burn, Illinois, All rights	s reserved under both	This docume level parts, t	ent is a declaration e	on of the sub ncompasses	ostances w all lower	vithin the manufacture level materials for wh	er listed it hich the m	tem. Note: if nanufacturer l	the item is an as	sembly with lower responsibility.	
1752-21.1 IPC Web Site for Information on http://www.ipc.org/IPC-175x	1 IPC Web Site for Information on IPC-1752 Standard Form Typ			Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information					n			
Supplier Information												
Company name*	pany name* Company unique ID			Unique ID Authority				Response Date*				
onsemi								2025-06-05				
Contact Name	Title - Contact]	Phone - Contact*				Email - Contact*					
Product-Env-Stewards	-Env-Stewards Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
uthorized Representative* Title - Representative]	Phone - Representative*				Email - Representative*				
Product-Env-Stewards	Product Enviro Comp	ro Compliance			NA				Product-Env-Stewards@onsemi.com			
Requester Item Number Mfr Iter	n Number Mfr Ite	Mfr Item Name		Effective Date	Version	М	Manufacturing Site		Weight*	UOM	Unit Type	
MC74V 5G-L22	HC1GT00P5T SINGLE 2-INPUT NAND GAT		TE	2025-06-05		CI	CN1		1.19	mg	Each	
Manufacturing Proccess Information												
Terminal Plating / Grid Array Material	Yerminal Base Alloy J-STD-020 M		ISL Rating	Peak Process Body Temperatur		nperature	are Max Time at Peak Tempera		ure Numbe	r of Reflow Cyc	les	
Matte Tin (Sn) - annealed	Matte Tin (Sn) - annealed CU Alloy 1			260		С	30	secon	ds 3			
Comments												
level 1 - maximum time at peak temperature during s	dering is 10-30 second	ds										
For more information regarding material composition	please refer to page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth					
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of				
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted				
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.									
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the				
Supplier Digital Signature Ra	stislav Drska	Le							

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).									
Homogeneous Material Weight Unit of M		Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	0.03	mg	Supplier	Silicon (Si)	7440-21-3		0.03	mg	
Lead Frame	0.52	mg	Supplier	Silver (Ag)	7440-22-4		0.0926	mg	
			В	Nickel (Ni)	7440-02-0		0.1607	mg	
			Supplier	Iron (Fe)	7439-89-6		0.222	mg	
			Supplier	Copper (Cu)	7440-50-8		0.0447	mg	
Mold Compound-Black	0.6	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.06	mg	
			Supplier	Carbon Black (C)	1333-86-4		0.003	mg	
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.087	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		0.39	mg	
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.06	mg	
Plating	0.02	mg	Supplier	Tin (Sn)	7440-31-5		0.02	mg	
Wire Bond - Au	0.02	mg	Supplier	Gold (Au)	7440-57-5		0.02	mg	